Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

- 1-20. (Canceled)
- 21. (New) A light emitting device comprising:
- a first lead;
- a second lead;
- a first semiconductor light emitting element mounted on said first lead;
- a semiconductor element mounted on said first lead;
- a first wire connecting said first semiconductor light emitting element and said second lead;
- a second wire connecting said semiconductor element and said second lead;
- a silicone resin provided to enclose said first semiconductor light emitting element, said semiconductor element, at least a part of said first lead, at least a part of said second lead, and said first and second wires, and second silicone resin having a hardness not lower than 50 in JISA value.

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22. (New) A light emitting device according to claim 21, further comprising a third wire connecting said first semiconductor light emitting element and said first lead,

wherein said first lead having a slit formed therein between a portion where said first semiconductor light emitting element is mounted and a portion where said third wire is connected.

- 23. (New) A light emitting device according to claim 21, wherein said semiconductor element is a second semiconductor light emitting element.
- 24. (New) A light emitting device according to claim 23, wherein said first semiconductor light emitting element and said second semiconductor light emitting element are different in peak wavelength of light they emit.
- 25. (New) A light emitting device according to claim 21, wherein said silicone resin has a pre-curing viscosity in the range not lower than 100cp and not higher than 10000cp.
- 26. (New) A light emitting device according to claim 21, wherein said silicone resin has convex surface configuration.
- 27. (New) A light emitting device according to claim 21, wherein said silicone resin has a hardness not higher than 90 in JISA value.
- 28. (New) A light emitting device according to claim 21, further comprising a fluorescent element which is included in said silicone resin, absorbs light emitted

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from said first semiconductor light emitting element and releases light of a peak wavelength different from said light from said first semiconductor light emitting element.